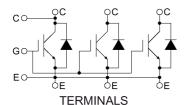
MBN1200E33D

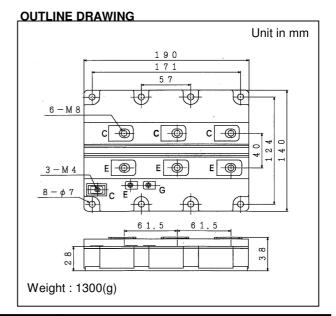
Silicon N-channel IGBT

FEATURES

- * High speed, low loss IGBT module.
- * Low driving power due to low input capacitance MOS gate.
- * Low noise due to ultra soft fast recovery diode.
- * High reliability, high durability module.
- * High thermal fatigue durability. (delta Tc=70°C, N>30,000cycles)
- * Isolated head sink (terminal to base). CIRCUIT DIAGRAM



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)



Item		Symbol	Unit	MBN1200E33D		
Collector Emitter Voltage		V_{CES}	V	3,300		
Gate Emitter Voltage		V_{GES}	V	±20		
Collector Current	DC	I _C	Α	1,200		
Collector Current	1ms	I _{Cp}	Α	2,400		
Forward Current	DC	l _F	Α	1,200		
I ofward Current	1ms	I _{FM}	Α	2,400		
Junction Temperature		T _i	°C	-40 ~ +125		
Storage Temperature		T _{stg}	°C	-40 ~ +125		
Isolation Voltage		V_{ISO}	V_{RMS}	6,000(AC 1 minute)		
Screw Torque	Terminals (M4/M8)	-	N·m	2/10 (1)		
	Mounting (M6)	-		6 (2)		

Notes: (1) Recommended Value 1.8±0.2/9±1N·m

(2) Recommended Value 5.5±0.5N·m

ELECTRICAL CHARACTERISTICS

ELECTRICAL CHARACTERISTICS							
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	12	$V_{CE}=3,300V, V_{GE}=0V, Tj=25^{\circ}C$
				-	20	60	V _{CE} =3,300V, V _{GE} =0V, Tj=125°C
Gate Emitter Leakage Current		I _{GES}	nA	-500	-	+500	$V_{GE}=\pm 20V, V_{CE}=0V, Tj=25^{\circ}C$
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	4.2	5.2	I _C =1,200A, V _{GE} =15V, Tj=125°C
Gate Emitter Threshold Voltage		$V_{GE(TO)}$	V	4.5	6.0	7.0	V _{CE} =10V, I _C =1,200mA, Tj=25°C
Input Capacitance		Cies	nF	-	110	-	V _{CE} =10V, V _{GE} =0V, f=100kHz, Tj=25°C
Internal Gate Resistance		Rge	Ω	-	1.2	-	V _{CE} =10V, V _{GE} =0V, f=100kHz, Tj=25°C
Switching Times	Rise Time	t _r	μs	-	1.9	3.1	V _{CC} =1,650V, Ic=1,200A
	Turn On Time	t _{on}		-	2.4	3.3	L=100nH
	Fall Time	t _f		-	1.0	2.5	$R_{G}=3.3\Omega$ (3)
	Turn Off Time	t _{off}		-	3.0	5.1	V _{GE} =±15V, Tj=125°C
Peak Forward Voltage Drop		V_{FM}	V	-	2.5	3.0	IF=1,200A, V _{GE} =0V, Tj=125°C
Reverse Recovery Time		t _{rr}	μs	-	0.6	1.1	Vcc=1,650V, IF=1,200A, L=100nH Tj=125°C
Turn On Loss		E _{on(10%)}	J/P	-	1.6	2.1	V _{CC} =1,650V, Ic=1,200A, L=100nH
Turn Off Loss		E _{off(10%)}	J/P	-	1.3	1.7	$R_{G}=3.3\Omega$ (3)
Reverse Recovery Loss		E _{rr(10%)}	J/P	-	1.2	1.9	V _{GE} =±15V, Tj=125°C
Stray inductance module		LSCE	nΗ	-	12	-	
Thermal Impedance	IGBT	Rth(j-c)	K/W	-	-	0.0085	Junction to case
	FWD	Rth(j-c)		-	-	0.017	dunction to case
Contact Thermal Impedance		Rth(c-f)	K/W	-	0.006	-	Case to fin

Notes:(3) R_G value is the test condition's value for evaluation of the switching times, not recommended value. Please, determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.

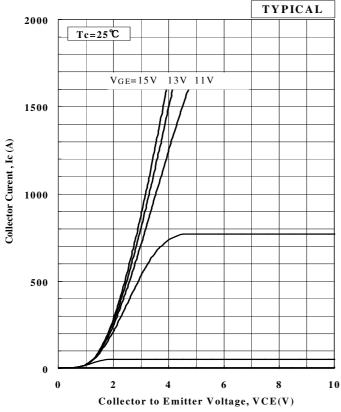
- * Please contact our representatives at order.
- * For improvement, specifications are subject to change without notice.
- * For actual application, please confirm this spec sheet is the newest revision.



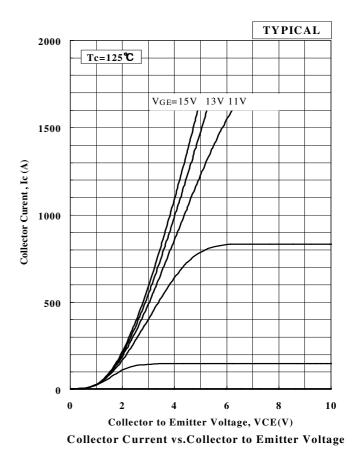
MBN1200E33D

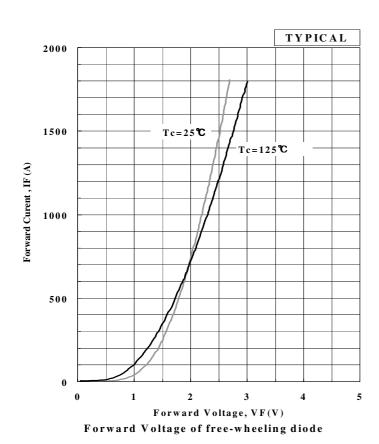
CHARACTERISTICS CURVE

STATIC CHARACTERISTICS



Collector Current vs.Collector to Emitter Voltage

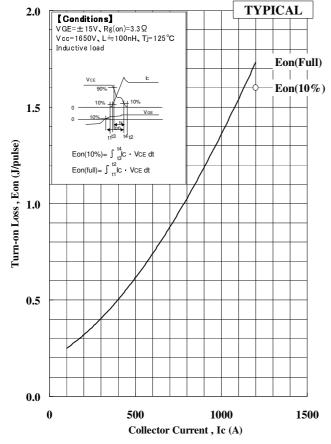




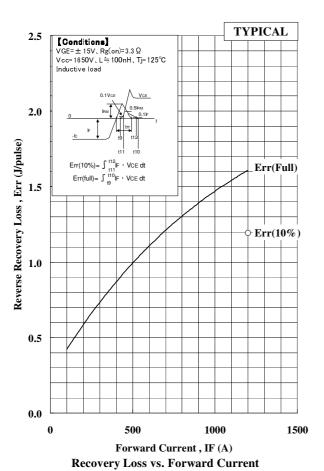


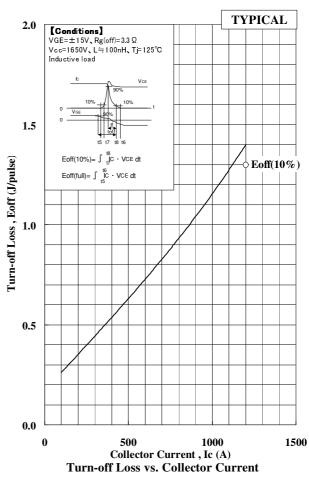
MBN1200E33D

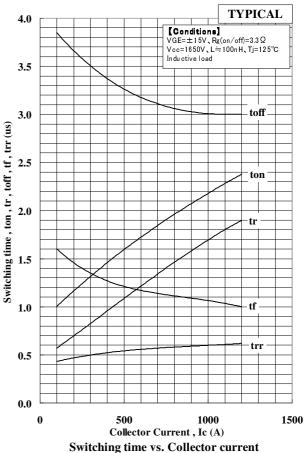
DEPENDENCE OF CURRENT



Turn-on Loss vs. Collector Current

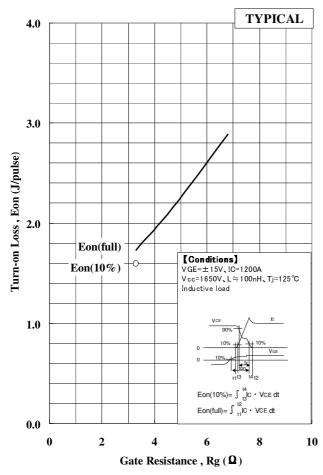




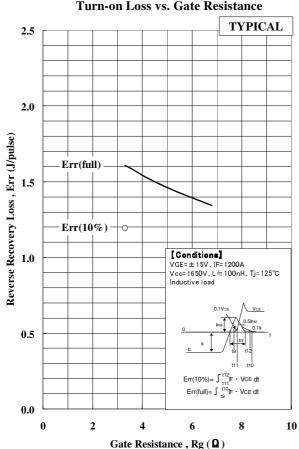


HITACHI Inspire the Next

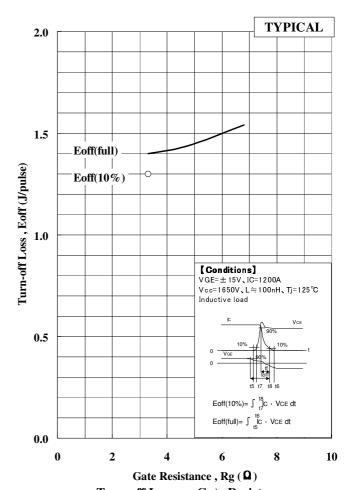
DEPENDENCE OF RG



Turn-on Loss vs. Gate Resistance



Recovery Loss vs. Gate Resistance

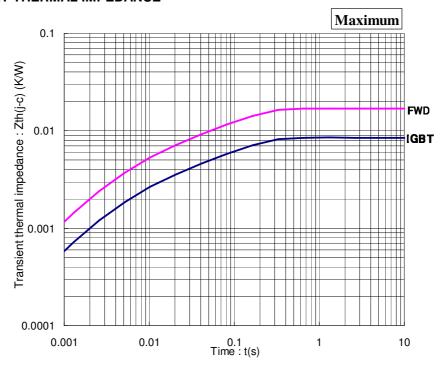


Turn-off Loss vs. Gate Resistance



1200E33I

TRANSIENT THERMAL IMPEDANCE



Transient Thermal Impedance Curve

Negative environmental impact materialPlease note the following negative environmental impact materials are contained in the product in order to keep product characteristic and reliability level.

Material	Contained part			
Lead (Pb) and its compounds	Solder			
Arsenic and its compounds	Si chip			



HITACHI POWER SEMICONDUCTORS

Notices

- 1. The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact Hitachi sales department for the latest version of this data sheets.
- 2. Please be sure to read "Precautions for Safe Use and Notices" in the individual brochure before use.
- 3. In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement. Or consult Hitachi's sales department staff.
- 4. In no event shall Hitachi be liable for any damages that may result from an accident or any other cause during operation of the user's units according to this data sheets. Hitachi assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in this data sheets.
- 5. In no event shall Hitachi be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 6. No license is granted by this data sheets under any patents or other rights of any third party or Hitachi, Ltd.
- 7. This data sheets may not be reproduced or duplicated, in any form, in whole or in part, without the expressed written permission of Hitachi, Ltd.
- 8. The products (technologies) described in this data sheets are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety not are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations.
- For inquiries relating to the products, please contact nearest overseas representatives which is located "Inquiry" portion on the top page of a home page.

Hitachi power semiconductor home page address http://www.hitachi.co.jp/products/power/pse/